

## Product Summary

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub>        | Package | I <sub>D</sub><br>T <sub>A</sub> = +25°C |
|-------------------|----------------------------|---------|--|
| 60V               | 3Ω @ V <sub>GS</sub> = 10V | SOT23   | 310mA                                    |
|                   | 4Ω @ V <sub>GS</sub> = 5V  |         | 270mA                                    |

## Description

This new generation MOSFET has been designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

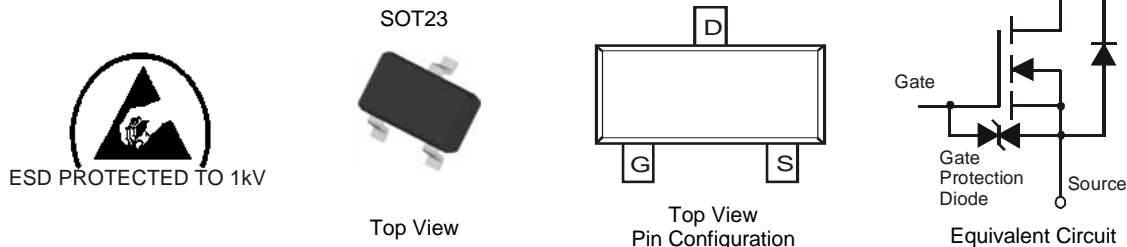
- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

## Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

## Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 <sup>Ⓔ3</sup>
- Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe).
- Terminal Connections: See Diagram
- Weight: 0.008487 grams (Approximate)

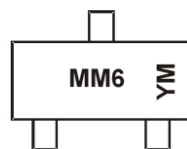


## Ordering Information (Note 4)

| Part Number | Case  | Packaging        |
|-------------|-------|------------------|
| DMN65D8L-7  | SOT23 | 3000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



MM6 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: D = 2016)  
 M = Month (ex: 9 = September)

### Date Code Key

| Year | 2011 | ~ | 2016 | 2017 | 2018 | 2019 | 2020 |
|------|------|---|------|------|------|------|------|
| Code | Y    | ~ | D    | E    | F    | G    | H    |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code  | 1   | 2   | 3   | 4   | 5   | 6   | 7   | 8   | 9   | O   | N   | D   |

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic  |              |                        | Symbol           | Value | Unit |
|---|--------------|------------------------|------------------|-------|------|
| Drain-Source Voltage                                    |              |                        | V <sub>DSS</sub> | 60    | V    |
| Gate-Source Voltage                                     |              |                        | V <sub>GSS</sub> | ±20   | V    |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V | Steady State | T <sub>A</sub> = +25°C | I <sub>D</sub>   | 310   | mA   |
|   |              | T <sub>A</sub> = +70°C |                  | 240   |      |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = 5V  | Steady State | T <sub>A</sub> = +25°C | I <sub>D</sub>   | 270   | mA   |
|   |              | T <sub>A</sub> = +70°C |                  | 210   |      |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)      |              |                        | I <sub>DM</sub>  | 800   | mA   |
| Maximum Body Diode Continuous Current (Note 5)          |              |                        | I <sub>S</sub>   | 500   | mA   |

**Thermal Characteristics**

| Characteristic                          |          | Symbol                            | Value       | Unit |
|---|----------|-----------------------------------|-------------|------|
| Total Power Dissipation                 | (Note 6) | P <sub>D</sub>                    | 370         | mW   |
|   | (Note 5) |                                   | 540         |      |
| Thermal Resistance, Junction to Ambient | (Note 6) | R <sub>θJA</sub>                  | 348         | °C/W |
|   | (Note 5) |                                   | 241         |      |
| Thermal Resistance, Junction to Case    | (Note 5) | R <sub>θJC</sub>                  | 91          | °C   |
| Operating and Storage Temperature Range |          | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                           | Symbol              | Min | Typ  | Max | Unit | Test Condition   |
|--|---------------------|-----|------|-----|------|--|
| <b>OFF CHARACTERISTICS (Note 7)</b>      |                     |     |      |     |      |  |
| Drain-Source Breakdown Voltage           | BV <sub>DSS</sub>   | 60  | —    | —   | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA   |
| Zero Gate Voltage Drain Current          | I <sub>DSS</sub>    | —   | —    | 1.0 | µA   | V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V  |
| Gate-Body Leakage                        | I <sub>GSS</sub>    | —   | —    | ±5  | µA   | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V   |
| <b>ON CHARACTERISTICS (Note 7)</b>       |                     |     |      |     |      |  |
| Gate Threshold Voltage                   | V <sub>GS(TH)</sub> | 1.2 | —    | 2.0 | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250µA                                     |
| Static Drain-Source On-Resistance        | R <sub>DS(ON)</sub> | —   | 2    | 3   | Ω    | V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.115A   |
|  |                     | —   | 2.5  | 4   | Ω    | V <sub>GS</sub> = 5V, I <sub>D</sub> = 0.115A  |
| Forward Transconductance                 | g <sub>FS</sub>     | 80  | 290  | —   | ms   | V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.115A   |
| Diode Forward Voltage                    | V <sub>SD</sub>     | —   | 0.8  | 1.2 | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA   |
| <b>DYNAMIC CHARACTERISTICS (Note 8)</b>  |                     |     |      |     |      |  |
| Input Capacitance                        | C <sub>iSS</sub>    | —   | 22.0 | —   | pF   | V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz  |
| Output Capacitance                       | C <sub>oSS</sub>    | —   | 3.2  | —   |      |  |
| Reverse Transfer Capacitance             | C <sub>rSS</sub>    | —   | 2.0  | —   |      |  |
| Gate Resistance                          | R <sub>g</sub>      | —   | 79.9 | —   | Ω    | V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz   |
| Total Gate Charge V <sub>GS</sub> = 10V  | Q <sub>g</sub>      | —   | 0.87 | —   | nC   | V <sub>GS</sub> = 10V, V <sub>DS</sub> = 30V, I <sub>D</sub> = 150mA                           |
| Total Gate Charge V <sub>GS</sub> = 4.5V | Q <sub>g</sub>      | —   | 0.43 | —   |      |  |
| Gate-Source Charge                       | Q <sub>gs</sub>     | —   | 0.11 | —   |      |  |
| Gate-Drain Charge                        | Q <sub>gd</sub>     | —   | 0.11 | —   |      |  |
| Turn-On Delay Time                       | t <sub>D(ON)</sub>  | —   | 2.7  | —   | ns   | V <sub>DD</sub> = 30V, I <sub>D</sub> = 0.115A, V <sub>GEN</sub> = 10V, R <sub>GEN</sub> = 25Ω |
| Turn-On Rise Time                        | t <sub>R</sub>      | —   | 2.8  | —   |      |  |
| Turn-Off Delay Time                      | t <sub>D(OFF)</sub> | —   | 12.6 | —   |      |  |
| Turn-Off Fall Time                       | t <sub>F</sub>      | —   | 7.3  | —   |      |  |

- Notes:
- Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout
  - Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
  - Short duration pulse test used to minimize self-heating effect.
  - Guaranteed by design. Not subject to production testing

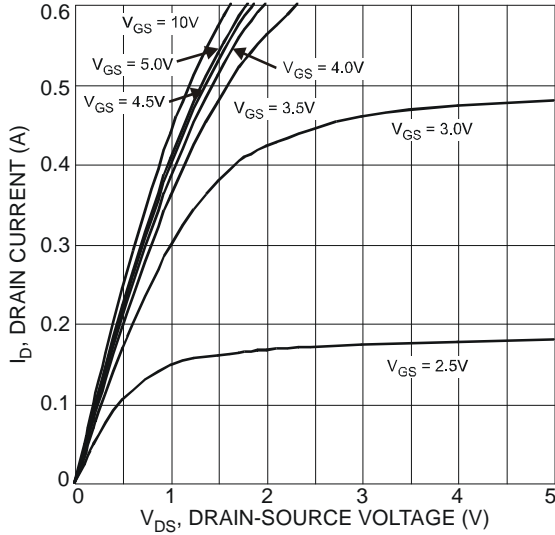


Figure 1. Typical Output Characteristic

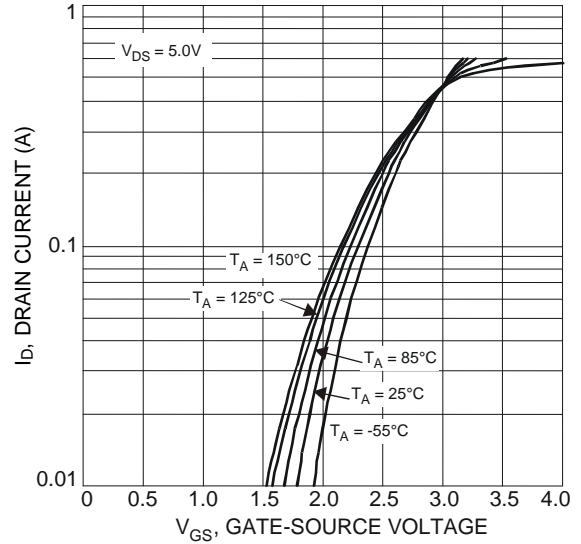


Figure 2. Typical Transfer Characteristics

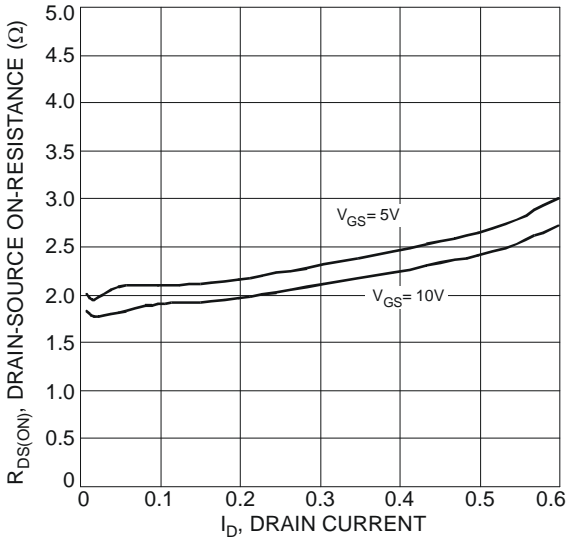


Figure 3. Typical On-Resistance vs. Drain Current and Temperature

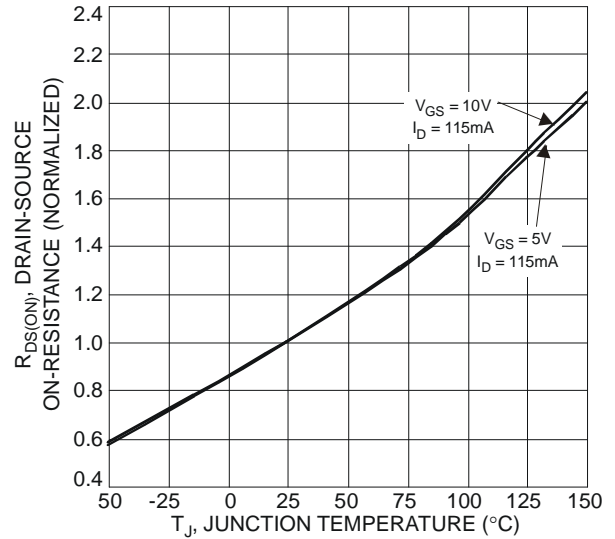


Figure 4. On-Resistance Variation with Temperature

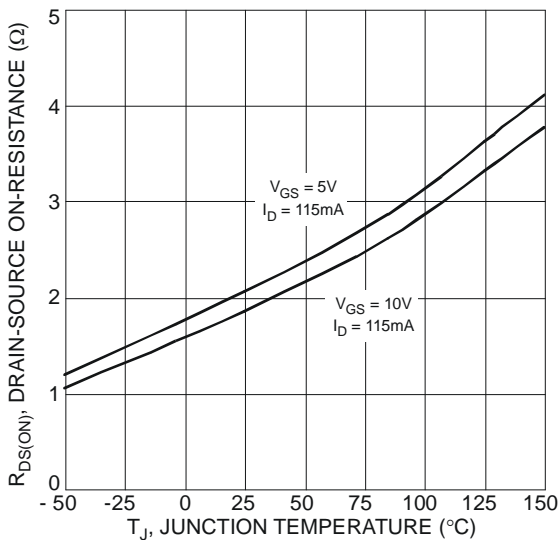


Figure 5. On-Resistance Variation with Temperature

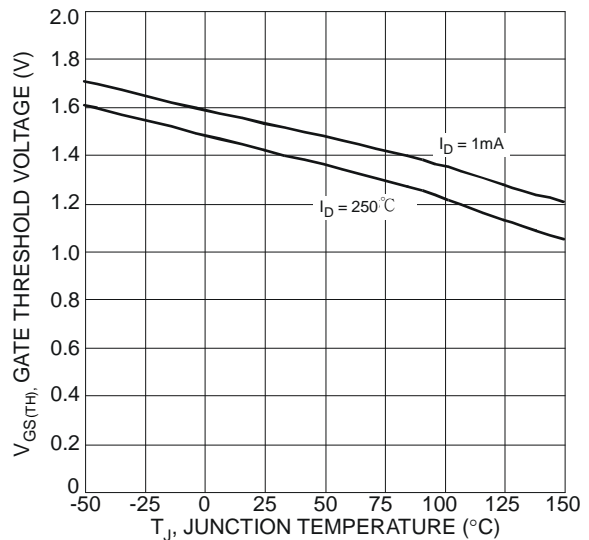


Figure 6. Gate Threshold Variation vs. Ambient Temperature

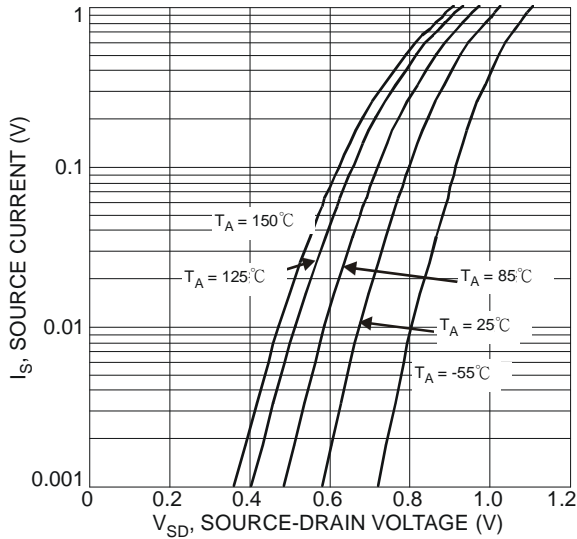


Figure 7. Diode Forward Voltage vs. Current

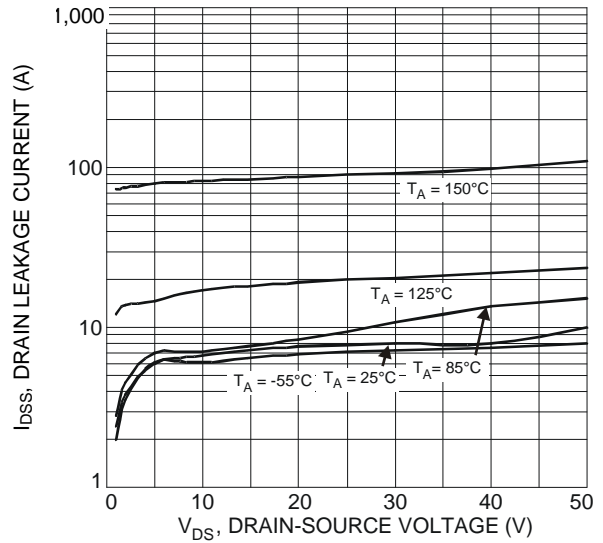


Figure 8. Typical Drain-Source Leakage Current vs. Voltage

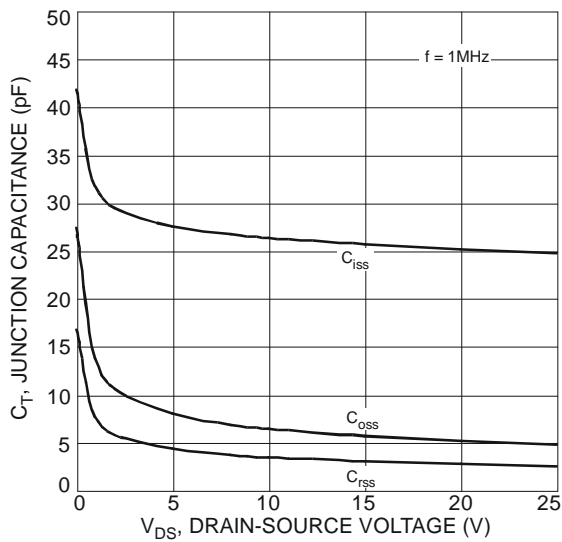
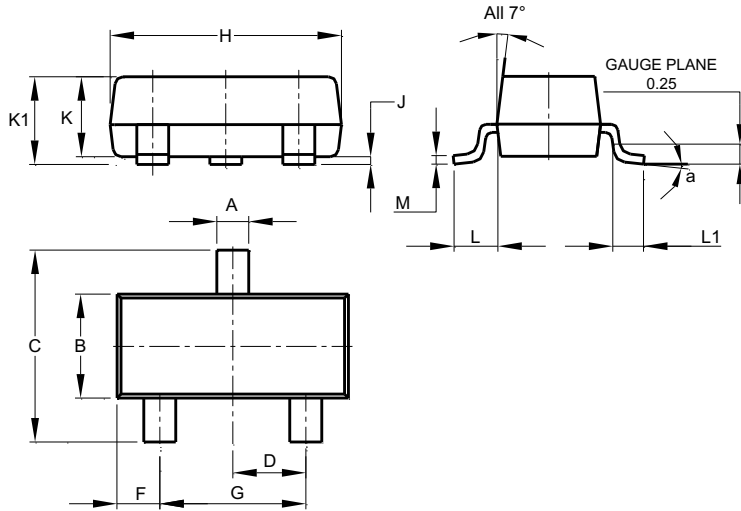


Figure 9. Typical Junction Capacitance

**Package Outline Dimensions**

Please see AP02001 at [http://www.diodes.com/\\_files/datasheets/ap02001.pdf](http://www.diodes.com/_files/datasheets/ap02001.pdf) for the latest version.

**SOT23**

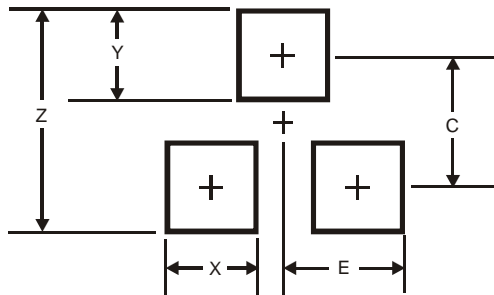


| SOT23                |       |       |       |
|----------------------|-------|-------|-------|
| Dim                  | Min   | Max   | Typ   |
| A                    | 0.37  | 0.51  | 0.40  |
| B                    | 1.20  | 1.40  | 1.30  |
| C                    | 2.30  | 2.50  | 2.40  |
| D                    | 0.89  | 1.03  | 0.915 |
| F                    | 0.45  | 0.60  | 0.535 |
| G                    | 1.78  | 2.05  | 1.83  |
| H                    | 2.80  | 3.00  | 2.90  |
| J                    | 0.013 | 0.10  | 0.05  |
| K                    | 0.890 | 1.00  | 0.975 |
| K1                   | 0.903 | 1.10  | 1.025 |
| L                    | 0.45  | 0.61  | 0.55  |
| L1                   | 0.25  | 0.55  | 0.40  |
| M                    | 0.085 | 0.150 | 0.110 |
| a                    | 8°    |       |       |
| All Dimensions in mm |       |       |       |

**Suggested Pad Layout**

Please see AP02001 at [http://www.diodes.com/\\_files/datasheets/ap02001.pdf](http://www.diodes.com/_files/datasheets/ap02001.pdf) for the latest version.

**SOT23**



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 2.9           |
| X          | 0.8           |
| Y          | 0.9           |
| C          | 2.0           |
| E          | 1.35          |

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